



LTEM NO.: SNO-1305-B (Consumer Electronics)

(14.0L × 11.2W × 1.4H & NANO-SIM Sockets)

## MEMORY-CARD-SOCKETS



### Technical parameter

表面贴装 SMT

| PROJECT                      | LEVEL                      | A[better product]           | B[average product]   |
|------------------------------|----------------------------|-----------------------------|----------------------|
|                              |                            |                             |                      |
| <b>Electrical Properties</b> | Contact Rating             | 50mA, 24V DC                |                      |
|                              | Initial Contact Resistance | 50mΩ max.                   | 80mΩ max.            |
|                              | Insulation Resistance      | 100MΩ min. 500V DC          |                      |
|                              | Withstand Voltage          | 500V AC for 1 minute        | 350 V AC for 1 minut |
| <b>Durable Performance</b>   | There No Load              | 5,000 Cycles                | 3,500 Cycles         |
|                              | Rated Load                 | 3,500 Cycles                | 2,500 Cycles         |
|                              | Storage temp.              | -35℃~+75℃(Operating Temp: ) |                      |

上掀操作 HINGE

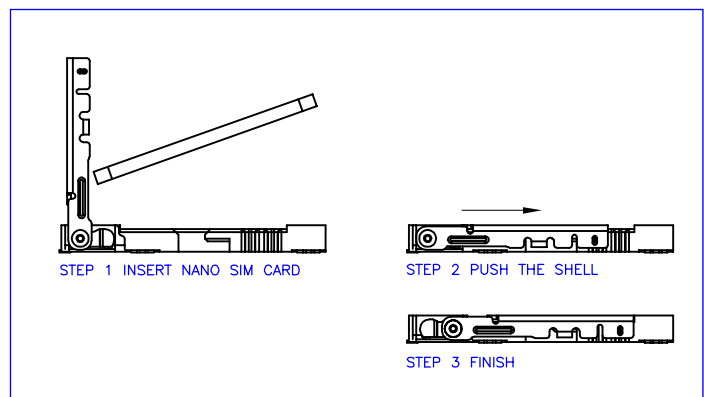
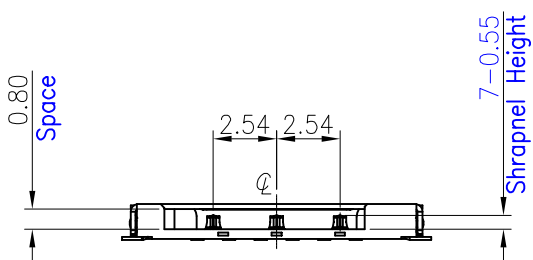
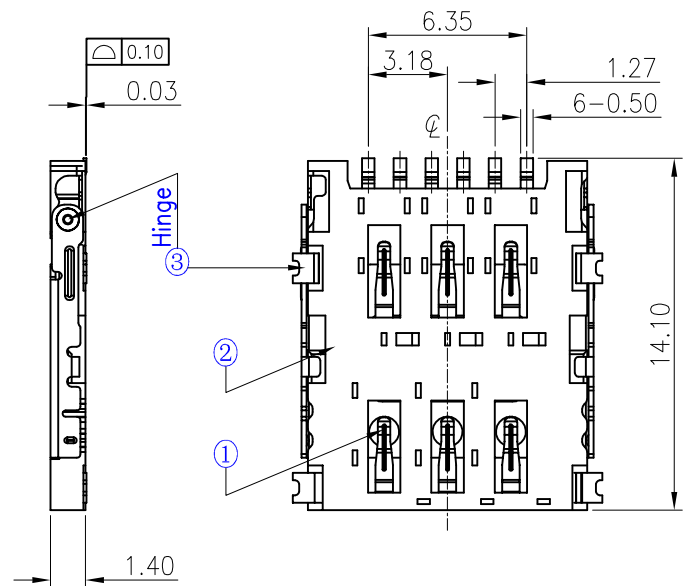
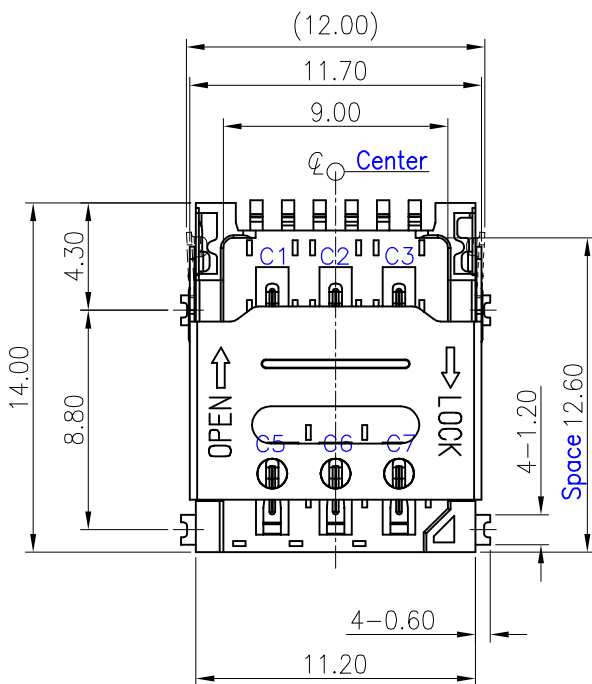
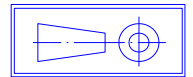
精密部品 NICETY

可靠 STABILIZE

適合環保 RoHS

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Unit:mm

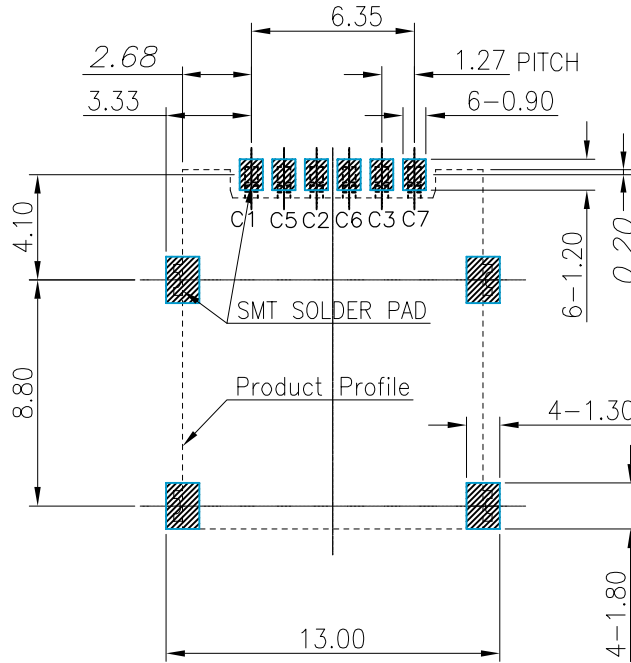


Operating Force

Inward 2.5~4.5N. (1N.=100gram-force)  
 Exiting 2.5~4.5N. (1N.=100gram-force)

Solder-ability (Max.)

IR Reflow: 255°C, 5sec. Manual: 350°C, 3sec.

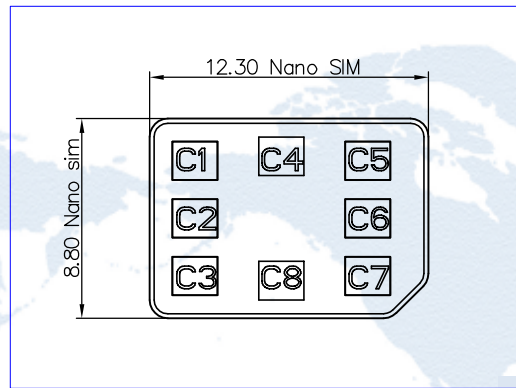


| DECIMALS    | ANGLES      |
|-------------|-------------|
| .X :±0.20   | X.° :±1.5°  |
| .XX :±0.10  | X.X° :±1.0° |
| .XXX :±0.05 | XXX° :±0.5° |

Pin definition

SIM CARD

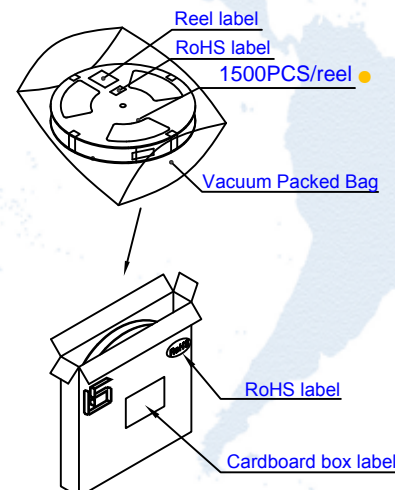
| Pin No. | Pin NAME | Type | Description |
|---------|----------|------|-------------|
| C ①     | 卡電源      | 1    | VCC         |
| C ②     | 復位       | 1    | RST         |
| C ③     | 時鐘       | 1    | CLK         |
| C ⑤     | 接地       | 1    | GND         |
| C ⑥     | Vpp      | 1    | VPP         |
| C ⑦     | 輸入/輸出    | 1    | I/O         |



NANO-SIM

Material declaration

| NAME            | MATERIAL                                | PLATING |
|-----------------|---|---------|
| ① 接觸端子 Terminal | C5210-EH (t=0.12mm)磷銅【镍基 Ni50u” 鍍金 1u”】 | G/F     |
| ② 基座 Housing    | LCP 耐热塑胶 (UL94V-0) BLACK                | SET     |
| ③ 上盖 Cover      | SUS304-H(t=0.20mm)不锈钢【GND 焊点鍍金 1u”】     | AU/Ni   |



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单击下面可查看定价，库存，交付和生命周期等信息

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